



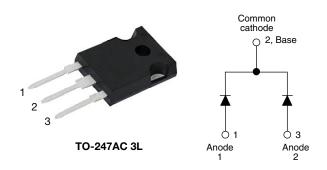
深圳创唯电子有限公司

http://www.vishay-ic.com

Vishay Semiconductors

www.vishay.com

Hyperfast Rectifier, 2 x 40 A FRED Pt®



PRIMARY CHARACTERISTICS									
I _{F(AV)}	2 x 40 A								
V _R	300 V								
V _F at I _F	0.94 V								
t _{rr} typ.	34 ns								
T _J max.	175 °C								
Package	TO-247AC 3L								
Circuit configuration	Common cathode								

FEATURES

- Hyperfast recovery time
- Low forward voltage drop
- Low leakage current

JEDEC[®]-JESD 47

- 175 °C operating junction temperature
 Designed and gualified according to
- RoHS COMPLIANT HALOGEN
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTIONS / APPLICATIONS

VS-80CPH03... series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of welding, SMPS, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS						
Repetitive peak reverse voltage	V _{RRM}		300	V						
Average rectified forward currentper leg		T _C = 133 °C	40							
total device			80	A						
Non-repetitive peak surge current per leg	I _{FSM}	T _J = 25 °C, t _p = 10 ms	320							
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C						

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	300	-	-					
Forward voltage	V _F	I _F = 40 A	-	1.07	1.25	V				
	۷F	I _F = 40 A, T _J = 125 °C	-	0.94	-					
Reverse leakage current		$V_{R} = V_{R}$ rated	-	-	10					
neverse leakage current	IR	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	-	μA 300					
Junction capacitance	CT	V _R = 300 V	-	75	-	pF				
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	3.5	-	nH				

 Revision: 27-Nov-2018
 1
 Document Number: 93270

 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
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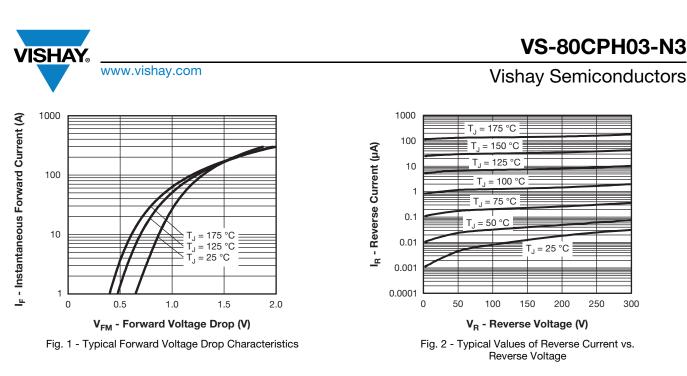


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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST C	ONDITIONS	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		$I_F = 1.0 \text{ A}, \text{ di}_F/\text{dt} = 1.0 \text{ A}$	100 A/µs, V _R = 30 V	-	34	-				
	+	I _F = 1.0 A, di _F /dt =	50 A/µs, V _R = 30 V	-	-	35	ns			
	t _{rr}	T _J = 25 °C		-	41	-	115			
		T _J = 125 °C		-	62	-				
Deals receiver a surrent		T _J = 25 °C	$I_F = 40 \text{ A}$	-	3.3	-	^			
Peak recovery current	I _{RRM}	T _J = 125 °C	di _F /dt = - 200 A/µs V _B = 200 V	-	8.5	-	A			
Reverse recovery charge	0	T _J = 25 °C		-	68	-	nC			
	Q _{rr}	T _J = 125 °C		-	265	-	nc			

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Maximum junction and storage temperature range	TJ, T _{Stg}		-65	-	175	°C				
Thermal resistance, junction to case per leg	R _{thJC}		-	0.47	0.80					
Thermal resistance, junction to ambient per leg	R _{thJA}	Typical socket mount	-	-	40 °C/	°C/W				
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.4	-					
Weight			-	6.0	-	g				
Weight			-	0.22	-	oz.				
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)				
Marking device		Case style TO-247AC 3L	80CPH03							



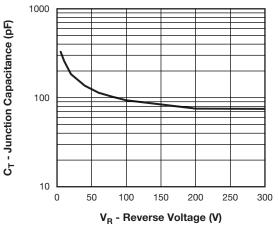


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

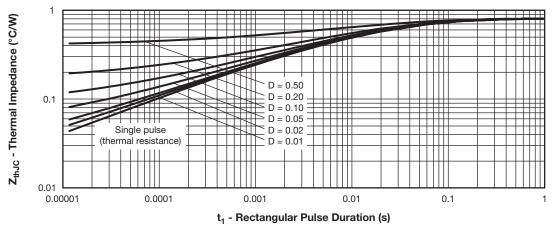
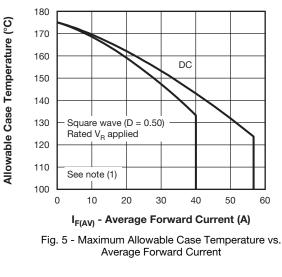


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

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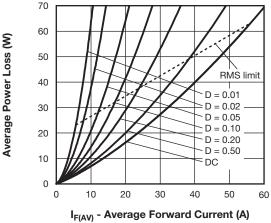
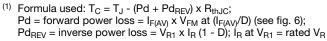
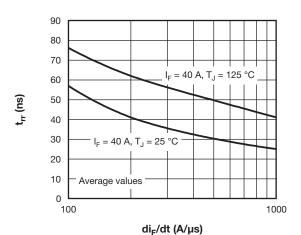


Fig. 6 - Forward Power Loss Characteristics

Note







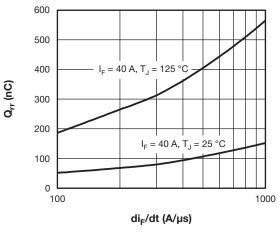


Fig. 8 - Typical Stored Charge vs. di_F/dt





ORDERING INFORMATION TABLE

Device code	VS-	80	С	Р	Н	03	-N3
		2	3	4	5	6	7
	1 -		,	niconduo		oduct	
	2 - 3 -			ng (80 = iguratior	,		
	4 -		commo TO-247	on catho AC	de		
	5 - 6 -			nst rectif)	
	7 -			ntal digit en-free,		complia	int and t

ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-80CPH03-N3	25	500	Antistatic plastic tube						

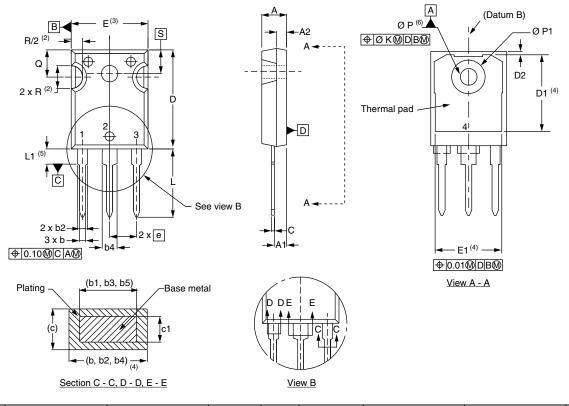
LINKS TO RELATED DOCUMENTS							
Dimensions www.vishay.com/doc?96138							
Part marking	www.vishay.com/doc?95007						



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TO-247AC 3L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWDOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	5 BSC	
b1	0.99	1.35	0.039	0.053			ØК	0.2	254	0.0)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			ØΡ	3.56	3.66	0.14	0.144	
b5	2.59	3.38	0.102	0.133			Ø P1	-	7.39	-	0.291	
С	0.38	0.89	0.015	0.035			Q	5.31	5.69	0.209	0.224	
c1	0.38	0.84	0.015	0.033			R	4.52	5.49	0.178	0.216	
D	19.71	20.70	0.776	0.815	3		S	5.51	BSC	0.217	' BSC	
D1	13.08	-	0.515	-	4							

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

(4) Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-247 with exception of dimension Q

Revision: 20-Jun-17

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